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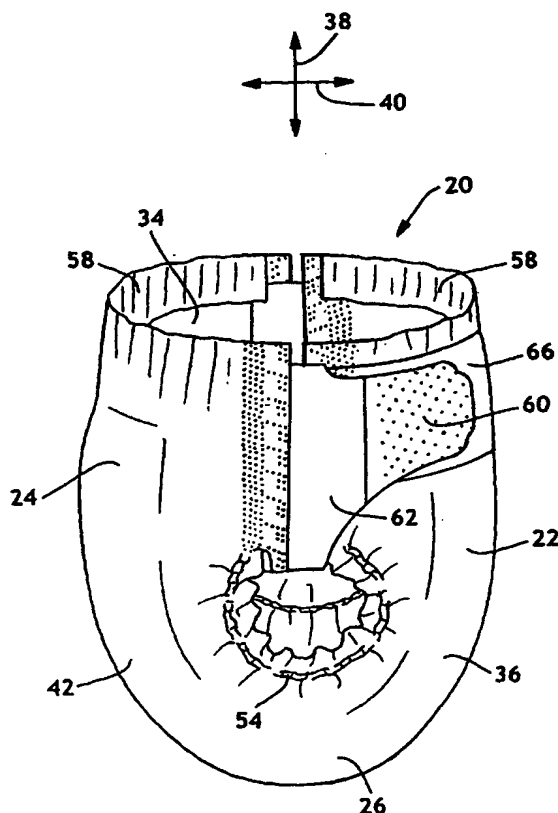
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(54) Title: **ABSORBENT ARTICLE HAVING DUAL PATTERN BONDING**



(57) Abstract: The present invention relates to improvements in bonding patterns for the attachment of components of disposable absorbent articles. For example, in order to provide attachment of an ear portion to a longitudinal side of the chassis of an article, there may be an attachment area. The attachment area may include an overlapping area of chassis material(s) (outer cover and/or liner materials) and ear portion material. The overlapping areas of chassis material and ear portion material are bonded together in such a way as to include a variegated bond pattern and a uniform bond pattern. The bonding patterns of the invention may also be used to form the side seams and passive side bonds for articles that are donned as pants.



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